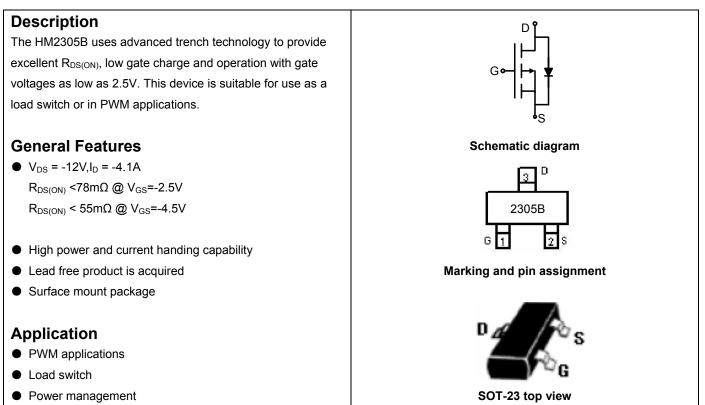
P-Channel Enhancement Mode Power MOSFET



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
2305B	HM2305B	SOT-23	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Paramete	Symbol	Limit	Unit		
Drain-Source Voltage	Vds	-12	V		
Gate-Source Voltage	Vgs	±12	V		
	T _C =25℃		-4.1	A	
Continuous Drain Current	T _C =70℃		-3.2		
Continuous Drain Current	T _A =25℃	– I _D	-3		
	T _A =70 ℃		-2.3		
Drain Current -Pulsed (Note 1)		I _{DM}	-15	A	
Maximum Power Dissipation		PD	1.7	W	
Operating Junction and Storage Temperature Range		T _J ,T _{STG}	-55 To 150	°C	

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	R _{θJA}	74	°C/W
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Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-12	-	-	V	
Zero Gate Voltage Drain Current	ate Voltage Drain Current I _{DSS} V _{DS} =-20V,V _{GS} =0V		-	-	-1	μA	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±12V,V _{DS} =0V	-	-	±100	nA	
On Characteristics (Note 3)	·		•				
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-0.4	-0.7	-1.0	V	
Drain Courses On State Desistence	P	V _{GS} =-4.5V, I _D =-4.1A	-	40	55		
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-2.5V, I _D =-3A	-	55	78	mΩ	
Forward Transconductance	g fs	V _{DS} =-5V,I _D =-2A	6	-	-	S	
Dynamic Characteristics (Note4)	·		•				
Input Capacitance	Clss	(1 - 4)(1)(1 - 0)(1 -	-	740	-	PF	
Output Capacitance	C _{oss}	V _{DS} =-4V,V _{GS} =0V, F=1.0MHz	-	290	-	PF	
Reverse Transfer Capacitance	Crss		-	190	-	PF	
Switching Characteristics (Note 4)							
Turn-on Delay Time	t _{d(on)}		-	12	-	nS	
Turn-on Rise Time	tr	V _{DD} =-4V,I _D =-3.3A ,	-	35	-	nS	
Turn-Off Delay Time	t _{d(off)}	R_{L} =-1.2 Ω , V_{GEN} =-4.5V, R_{g} =1 Ω	-	30	-	nS	
Turn-Off Fall Time	t _f		-	10	-	nS	
Total Gate Charge	Qg		-	7.8	-	nC	
Gate-Source Charge	Q _{gs}	V _{DS} =-4V,I _D =-4.1A,V _{GS} =-4.5V	-	1.2	-	nC	
Gate-Drain Charge	Q _{gd}		-	1.6	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-1.6A	-	-	-1.2	V	
Diode Forward Current (Note 2)	Is		-	-	1.6	А	

Electrical Characteristics (T_A=25[°]C unless otherwise noted)

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production

Typical Electrical and Thermal Characteristics

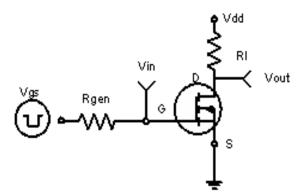
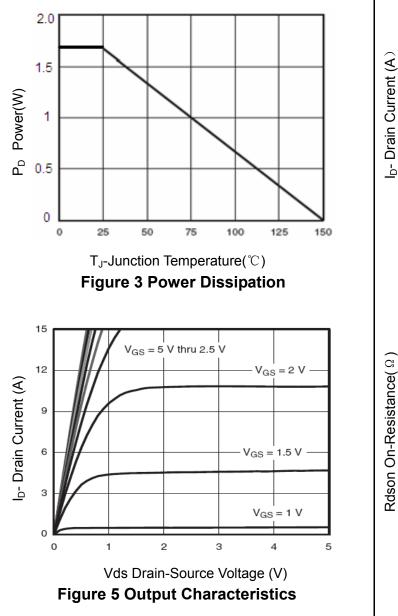
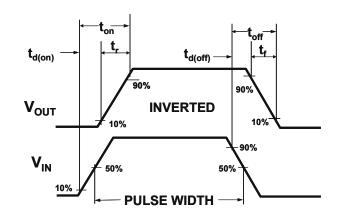


Figure 1:Switching Test Circuit







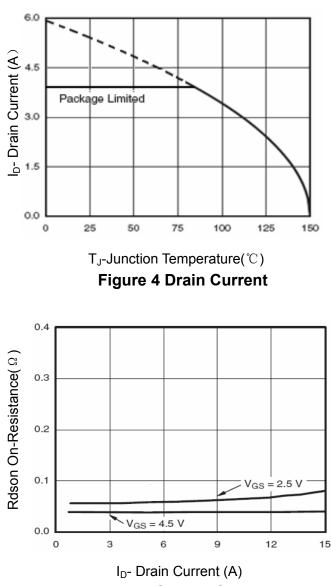
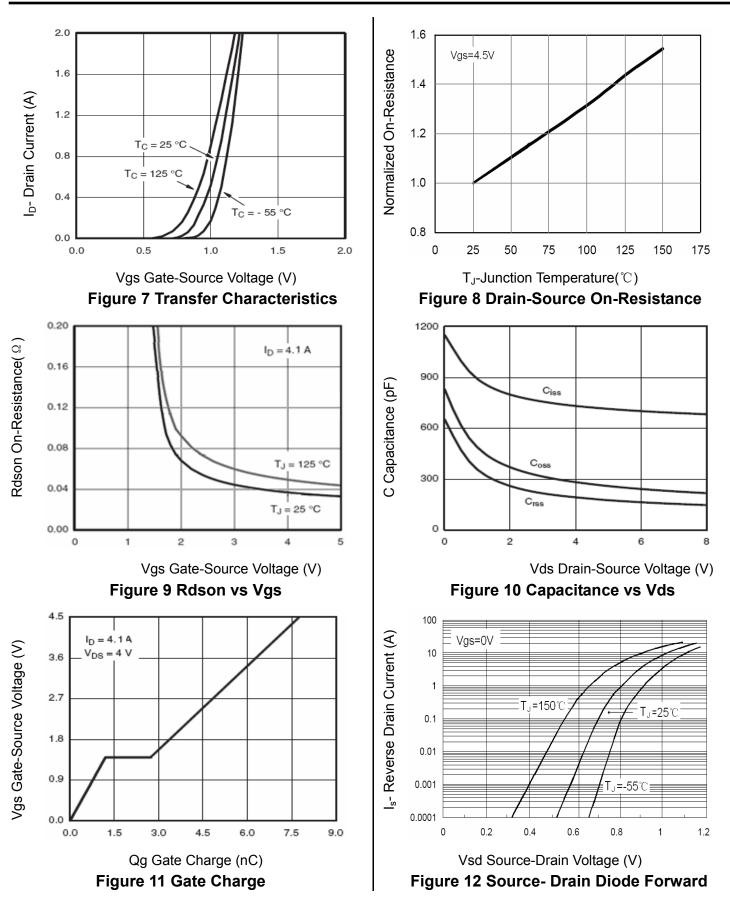


Figure 6 Drain-Source On-Resistance

HM2305B



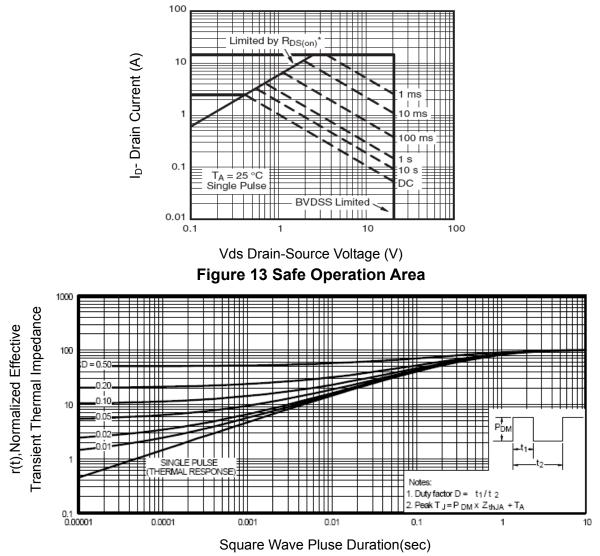
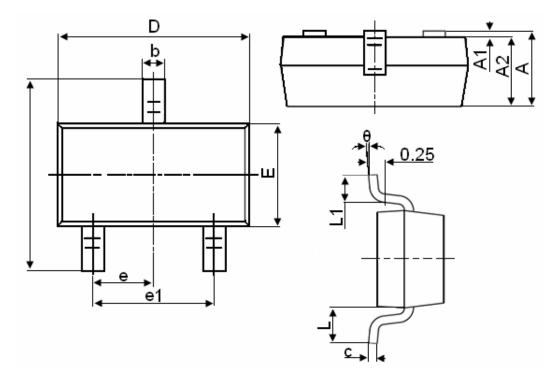


Figure 14 Normalized Maximum Transient Thermal Impedance

SOT-23 Package Information



Symbol	Dimensions in Millimeters			
	MIN.	MAX.		
A	0.900	1.150		
A1	0.000	0.100		
A2	0.900	1.050		
b	0.300	0.500		
с	0.080	0.150		
D	2.800	3.000		
E	1.200	1.400		
E1	2.250	2.550		
е	0.950TYP			
e1	1.800	2.000		
L	0.550REF			
L1	0.300	0.500		
θ	0°	8°		

Notes

- 1. All dimensions are in millimeters.
- 2. Tolerance ±0.10mm (4 mil) unless otherwise specified
- 3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
- 4. Dimension L is measured in gauge plane.
- 5. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

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